

# LNJ951C4BRA

## Ultra High Bright Surface Mounting Chip LED

Blue J Type

■ Absolute Maximum Ratings  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power dissipation	$P_D$	40	mW
Forward current	$I_F$	10	mA
Pulse forward current *	$I_{FP}$	50	mA
Reverse voltage	$V_R$	5	V
Operating ambient temperature	$T_{opr}$	-25 to +80	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-30 to +85	$^\circ\text{C}$

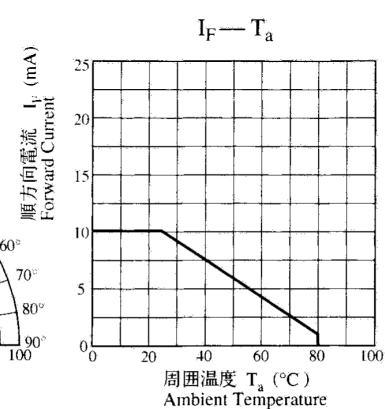
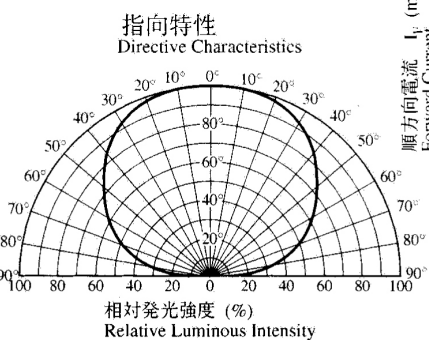
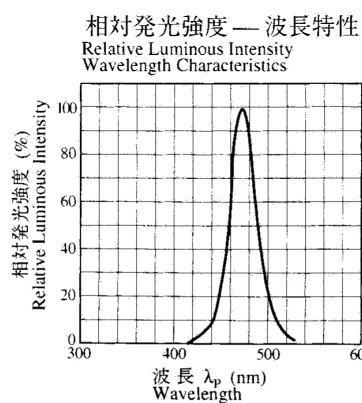
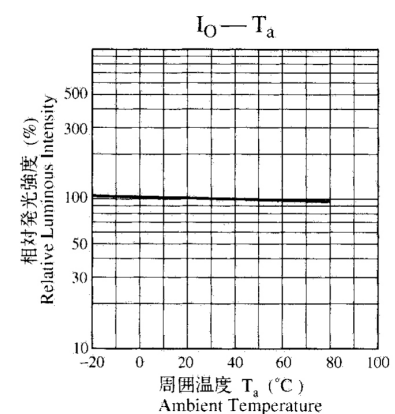
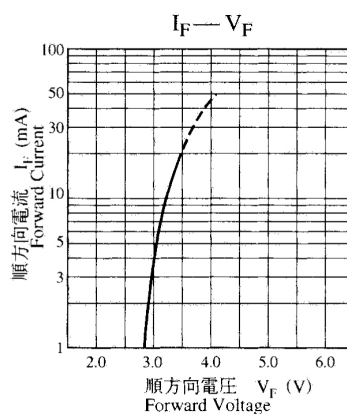
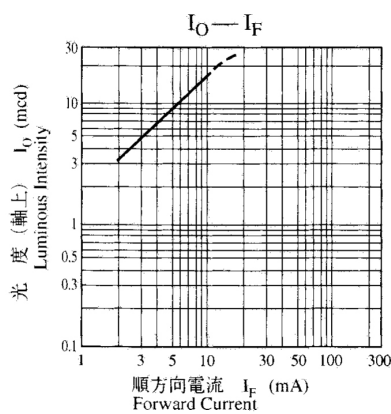
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 10 msec.

■ Lighting Color / Lens Color

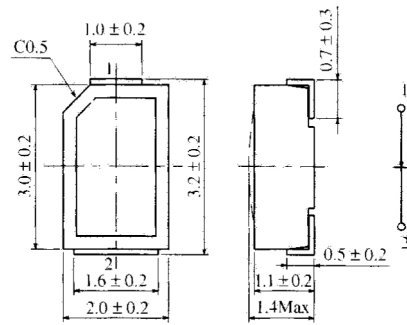
- Blue / Clear

■ Electro-Optical Characteristics  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity	$I_O$		3.0	9.0		mcd
Forward current	$I_F$			5		mA
Forward voltage	$V_F$	$I_F = 5\text{ mA}$		3.2	3.7	V
Peak emission wavelength	$\lambda_p$	$I_F = 5\text{ mA}$		470		nm
Spectral half band width	$\Delta\lambda$	$I_F = 5\text{ mA}$		30		nm
Reverse current	$I_R$	$V_R = 5\text{ V}$			10	$\mu\text{A}$



## ■ Package (Unit: mm)



- Pin name
- 1: Anode
- 2: Cathode

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